APPLICA	BLE STAN	DARD							
RATING	OPERATING TEMPERATUR	E RANGE	-30°C TO 85°C (NOTI	E 1)	STORAGE TEMPERAT	URE RANGE	-10°C TO 60°C (NO	TE 2))
	OPERATING HUMIDITY RANGE		40% TO 00%		STORAGE HUMIDITY F	PANGE	40% TO 70% (NOTI	= 2)	
	VOLTAGE	, J.	250V AC		I IOMIDITI	VOLTAGE		- - /	
			AWG 22 TO 26 :				ΔWG 22 ·	2A	
	CURRENT		AWG 28 : 1A AWG 30 : 0.5A		RATING	CURRENT	AWG 24 TO 28 :	1A	
							AWG 30 :	0. 5A	
			SPECII	FICAT	IONS				
IT	ЕМ		TEST METHOD			RE	QUIREMENTS	QT	АТ
	RUCTION				- Linna				
GENERAL EX	AMINATION		AND BY MEASURING INSTRUM	MENT.	ACCC	RDING TO	DRAWING.	X	X
MARKING	10.0114.04		ED VISUALLY.					Х	X
	IC CHARA RESISTANCE				20.00			_	
		100mA (DC OR 1000 Hz).			30m	30mΩ MAX.			_
NSULATION RESISTANC		500V D0	2.		1000	MΩ MIN.		X	_
VOLTAGE P		650V AC	AC FOR 1 min.			NO FLASHOVER OR BREAKDOWN.			_
MECHAN	NICAL CHA	RACTE	RISTICS		l			1	<u> </u>
MECHANICAL OPERATION		50 TIMES INSERTIONS AND EXTRACTIONS.			2 NO	 CONTACT RESISTANCE: 30mΩ MAX. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 			_
		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.			= ① NO	① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS. X			_
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.			ES OF				_
		_	ACTERISTICS						
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55 \rightarrow 5 TO 35 \rightarrow +85 \rightarrow 5 TO 35 °C TIME 30 \rightarrow 5 TO 15 \rightarrow 30 \rightarrow 5 TO15 min UNDER 5 CYCLES.			in ② IN: ③ NO	 CONTACT RESISTANCE: 30mΩ MAX. INSULATION RESISTANCE: 1000MΩ MIN. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 			_
DAMP HEAT (STEADY STATE)		EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.			② IN: ③ NO	1 CONTACT RESISTANCE: 30mΩ MAX. 2 INSULATION RESISTANCE: 500MΩ MIN. 3 NO DAMAGE, CRACK OR LOOSENESS OF PARTS.			_
COUNT DE		ESCRIPTION OF REVISIONS DESIGNATION DE SIGNATION DESIGNATION DESIGNATION DESIGNATION DESIGNATION DESIGNATION DESIGNATION DESIGNATION DESIGNATION DE SIGNATION DESIGNATION DE SIGNATION DESIGNATION DES			ESIGNED		CHECKED	DA	TE.
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lote OT:O:	ualification Tes	+ ΔT·Λοο	rance Test V. Annlischia Tast		DD 414"	DRAWN	KT. ISHTI ELC4-081534		2. 02
			urance Test X:Applicable Test		ART NO.	DF11-16DP-2V (57)		-U1	
HS.			CATION SHEET						4 12
	HIR	USE El	ECTRIC CO., LTD.	C	ODE NO.	CL5	543-0591-8-57 <i>l</i>	Δ\	1/2

	SPECIFICATIO	NS		
ITEM	TEST METHOD	REQUIREMENTS	QT	AT
RESISTANCE TO SOLDERING HEAT	1) AUTOMATIC SOLDERING (REFLOW) 《REFLOW AREA》 MAX 250°C WITHIN 10 sec. MIN 230°C WITHIN 60 sec. 《PREHEATING AREA》 150 TO 180°C 90 TO 120 sec. PUT THROUGH IN REFROW FUMACE TWICE. FEAVE IN AMBIENT TEMPERATURE AND HUMIDITY FOR 1 HOUR. CONNEVCTOR TEMPERATURE TO BE AMBIENT FOR SECOND REFLOW. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE :290±10°C, SOLDERING TIME :3s. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	_
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 230±5°C FOR IN IMMERSION , DURATION, 3 s.	A NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	Х	1

REMARKS

NOTE 1:INCLUDING THE TEMPERATURE RISE BY CURRENT.

NOTE 2:APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD , AFTER PCB BOARD , OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERM STORAGE DURING TRANSPORTATION.

MAX 240°C WITHIN 10 sec. MIN 230°C WITHIN 60 sec. 《PREHEATING AREA》

150 TO 180°C 90 TO 120 s.

Unless otherwise specifid, refer to JIS C 5402.

Note QT:Q	tualification Test AT:Assurance Test X:Applicable Test	DRAWING NO.		ELC4-081534-01		
HRS	SPECIFICATION SHEET	PART NO. DF11-16DP-2V (57))	
	HIROSE ELECTRIC CO., LTD.	CODE NO	CL543	-0591-8-57	A	2/2